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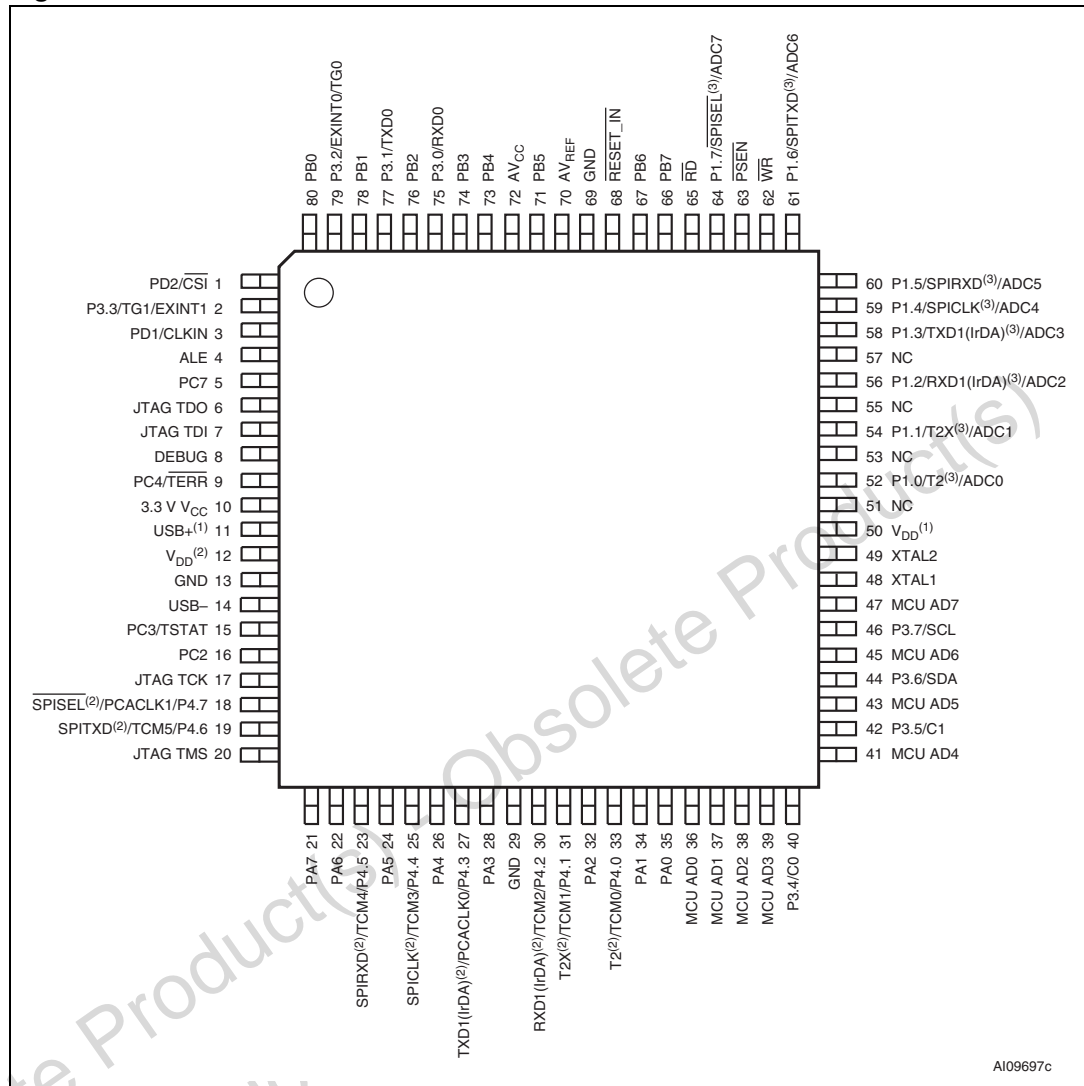
Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	8032
Core Size	8-Bit
Speed	40MHz
Connectivity	I ² C, IrDA, SPI, UART/USART, USB
Peripherals	LVD, POR, PWM, WDT
Number of I/O	35
Program Memory Size	80KB (80K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	52-LQFP
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/stmicroelectronics/upsd3422eb40t6

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Figure 3. LQFP80 connections



1. NC = Not connected
2. The USB+ pin needs a 1.5 kΩ pull-up resistor.
3. For 5 V applications, V_{DD} must be connected to a 5.0 V source. For 3.3 V applications, V_{DD} must be connected to a 3.3 V source.
4. These signals can be used on one of two different ports (Port 1 or Port 4) for flexibility. Default is Port1.

If an interrupt flag is not cleared after servicing the interrupt, an unwanted interrupt will occur upon exiting the ISR.

After the interrupt is serviced, the last instruction executed by the ISR is RETI. The RETI informs the MCU that the ISR is no longer in progress and the MCU pops the top two bytes from the stack and loads them into the PC. Execution of the interrupted program continues where it left off.

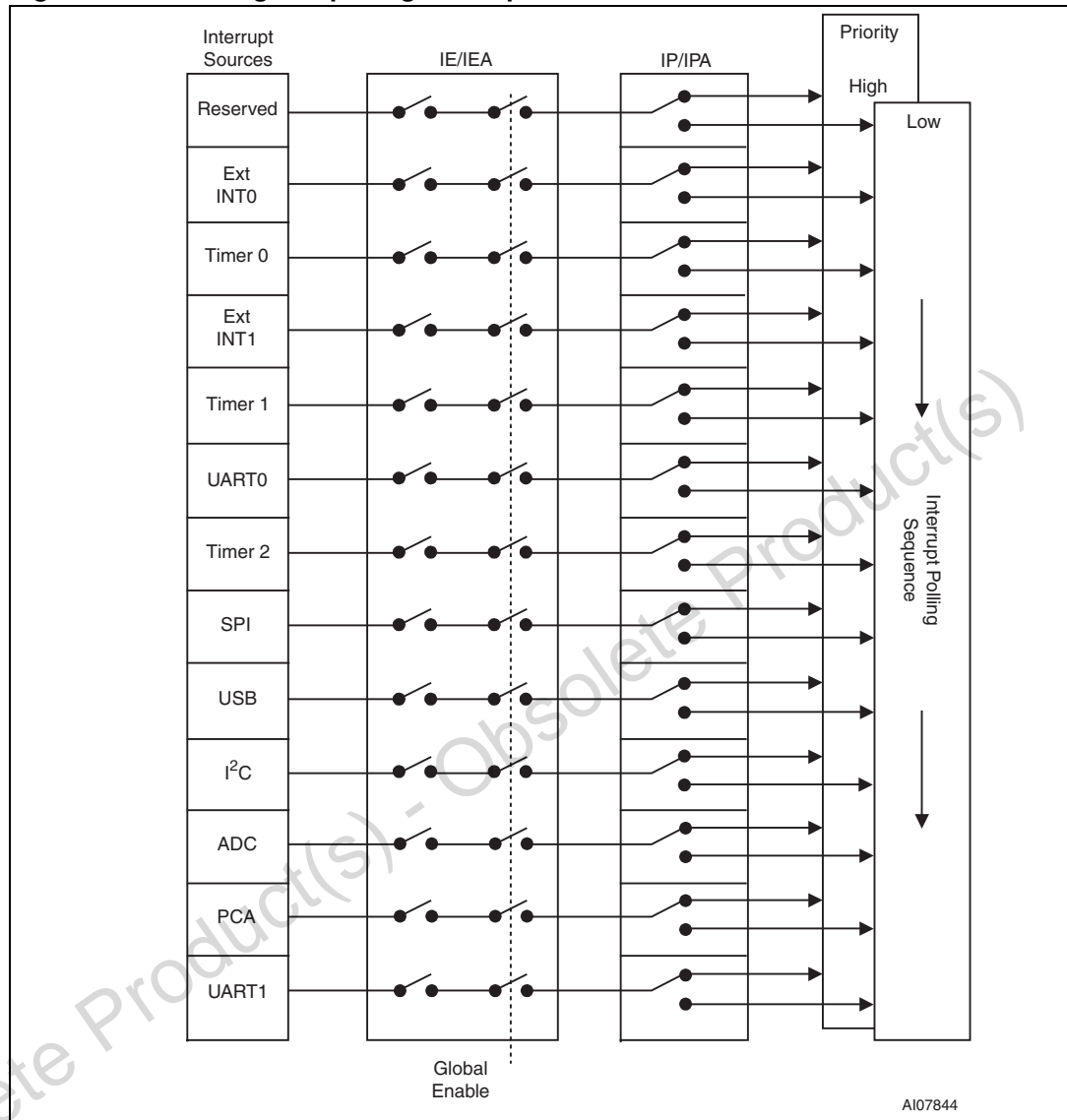
Note: An ISR must end with a RETI instruction, not a RET. An RET will not inform the interrupt control system that the ISR is complete, leaving the MCU to think the ISR is still in progress, making future interrupts impossible.

Table 17. Interrupt summary

Interrupt source	Polling priority	Vector addr	Flag bit name (SFR.bit position) 1 = Intr pending 0 = No interrupt	Flag bit auto-cleared by hardware?	Enable bit name (SFR.bit position) 1 = Intr Enabled 0 = Intr Disabled	Priority bit name (SFR.bit position) 1 = High Priority 0 = Low Priority
Reserved	0 (high)	0063h	–	–	–	–
External Interrupt INT0	1	0003h	IE0 (TCON.1)	Edge - Yes Level - No	EX0 (IE.0)	PX0 (IP.0)
Timer 0 Overflow	2	000Bh	TF0 (TCON.5)	Yes	ET0 (IE.1)	PT0 (IP.1)
External Interrupt INT1	3	0013h	IE1 (TCON.3)	Edge - Yes Level - No	EX1 (IE.2)	PX1 (IP.2)
Timer 1 Overflow	4	001Bh	TF1 (TCON.7)	Yes	ET1 (IE.3)	PT1 (IP.3)
UART0	5	0023h	RI (SCON0.0) TI (SCON0.1)	No	ES0 (IE.4)	PS0 (IP.4)
Timer 2 Overflow or TX2 Pin	6	002Bh	TF2 (T2CON.7) EXF2 (T2CON.6)	No	ET2 (IE.5)	PT2 (IP.5)
SPI	7	0053h	TEISF, RORISF, TISF, RISF (SPISTAT[3:0])	Yes	ESPI (IEA.6)	PSPI (IPA.6)
USB	8	0033h	– ⁽¹⁾	No	EUSB (IEA.0)	PUSB (IPA.0)
I ² C	9	0043h	INTR (S1STA.5)	Yes	EI ² C (IEA.1)	PI ² C (IPA.1)
ADC	10	003Bh	AINTF (ACON.7)	No	EADC (IEA.7)	PADC (IPA.7)
PCA	11	005Bh	OFVx, INTFx (PCASTA[0:7])	No	EPCA (IEA.5)	PPCA (IPA.5)
UART1	12 (low)	004Bh	RI (SCON1.0) TI (SCON1.1)	No	ES1 (IEA.4)	PS1 (IPA.4)

1. See USB interrupt flag registers UIF0-3.

Figure 12. Enabling and polling interrupts



13.1 Individual interrupt sources

13.1.1 External interrupts Int0 and Int1

External interrupt inputs on pins EXTINT0 and EXTINT1 (pins 3.2 and 3.3) are either edge-triggered or level-triggered, depending on bits IT0 and IT1 in the SFR named TCON.

When an external interrupt is generated from an edge-triggered (falling-edge) source, the appropriate flag bit (IE0 or IE1) is automatically cleared by hardware upon entering the ISR.

When an external interrupt is generated from a level-triggered (low-level) source, the appropriate flag bit (IE0 or IE1) is NOT automatically cleared by hardware.

Table 41. P3SFS: Port 3 special function select register (SFR 91h, reset value 00h)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P3SFS7	P3SFS6	P3SFS5	P3SFS4	P3SFS3	P3SFS2	P3SFS1	P3SFS0

Table 42. P3SFS register bit definition

Port 3 Pin	R/W	Default port function	Alternate port function
		P3SFS[i] - 0; Port 3 Pin, i = 0..7	P3SFS[i] - 1; Port 3 Pin, i = 0..7
0	R,W	GPIO	UART0 Receive, RXD0
1	R,W	GPIO	UART0 Transmit, TXD0
2	R,W	GPIO	Ext Intr 0/Timer 0 Gate, EXT0INT/TG0
3	R,W	GPIO	Ext Intr 1/Timer 1 Gate, EXT1INT/TG1
4	R,W	GPIO	Counter 0 Input, C0
5	R,W	GPIO	Counter 0 Input, C1
6	R,W	GPIO	I ² C Data, I2CSDA
7	R,W	GPIO	I ² C Clock, I2CCL

Table 43. P1SFS0: Port 1 special function select 0 register (SFR 8Eh, reset value 00h)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P1SF07	P1SF06	P1SF05	P1SF04	P1SF03	P1SF02	P1SF01	P1SF00

Table 44. P1SFS1: Port 1 special function select 1 register (SFR 8Fh, reset value 00h)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P1SF17	P1SF16	P1SF15	P1SF14	P1SF13	P1SF12	P1SF11	P1SF10

Table 45. P1SFS0 and P1SFS1 details

Port 1 Pin	R/W	Default port function	Alternate 1 port function	Alternate 2 port function
		P1SFS0[i] = 0 P1SFS1[i] = x	P1SFS0[i] = 1 P1SFS1[i] = 0	P1SFS0[i] = 1 P1SFS1[i] = 1
		Port 1 Pin, i = 0.. 7	Port 1 Pin, i = 0.. 7	Port 1 Pin, i = 0.. 7
0	R,W	GPIO	Timer 2 count input, T2	ADC Chn 0 input, ADC0
1	R,W	GPIO	Timer 2 trigger input, TX2	ADC Chn 1 input, ADC1
2	R,W	GPIO	UART1 Receive, RXD1	ADC Chn 2 input, ADC2
3	R,W	GPIO	UART1 Transmit, TXD1	ADC Chn 3 input, ADC3
4	R,W	GPIO	SPI Clock, SPICLK	ADC Chn 4 input, ADC4
5	R,W	GPIO	SPI Receive, SPIRXD	ADC Chn 5 input, ADC5

Table 50. BUSCON register bit definition

Bit	Symbol	R/W	Definition
7	EPFQ	R,W	Enable pre-fetch queue 0 = PFQ is disabled 1 = PFQ is enabled (default)
6	EBC	R,W	Enable branch cache 0 = BC is disabled 1 = BC is enabled (default)
5:4	WRW[1:0]	R,W	\overline{WR} Wait, number of MCU_CLK periods for \overline{WR} write bus cycle during any MOVX instruction 00b: 4 clock periods 01b: 5 clock periods 10b: 6 clock periods (default) 11b: 7 clock periods
3:2	RDW[1:0]	R,W	\overline{RD} Wait, number of MCU_CLK periods for \overline{RD} read bus cycle during any MOVX instruction 00b: 4 clock periods 01b: 5 clock periods 10b: 6 clock periods (default) 11b: 7 clock periods
1:0	CW[1:0]	R,W	Code Wait, number of MCU_CLK periods for \overline{PSEN} read bus cycle during any code byte fetch or during any MOVC code byte read instruction. Periods will increase with PFQ stall 00b: 3 clock periods - exception, for MOVC instructions this setting results 4 clock periods 01b: 4 clock periods 10b: 5 clock periods 11b: 6 clock periods (default)

Table 69. Commonly used baud rates generated from timer 1 (continued)

UART mode	f _{osc} MHz	Desired baud rate	Resultant baud rate	Baud rate deviation	SMOD bit in PCON	Timer 1		
						C/ \bar{T} Bit in TMOD	Timer mode in TMOD	TH1 reload value (hex)
Modes 1 or 3	3.6864	19200	19200	0	1	0	2	FF
Modes 1 or 3	3.6864	9600	9600	0	1	0	2	FE
Modes 1 or 3	1.8432	9600	9600	0	1	0	2	FF
Modes 1 or 3	1.8432	4800	4800	0	1	0	2	FE

21.4 More about UART mode 0

Refer to the block diagram in [Figure 30 on page 113](#), and timing diagram in [Figure 31 on page 113](#).

Transmission is initiated by any instruction which writes to the SFR named SBUF. At the end of a write operation to SBUF, a 1 is loaded into the 9th position of the transmit shift register and tells the TX Control unit to begin a transmission. Transmission begins on the following MCU machine cycle, when the "SEND" signal is active in [Figure 31](#).

SEND enables the output of the shift register to the alternate function on the port containing pin RxD, and also enables the SHIFT CLOCK signal to the alternate function on the port containing the pin, TxD. At the end of each SHIFT CLOCK in which SEND is active, the contents of the transmit shift register are shifted to the right one position.

As data bits shift out to the right, zeros come in from the left. When the MSB of the data byte is at the output position of the shift register, then the '1' that was initially loaded into the 9th position, is just to the left of the MSB, and all positions to the left of that contain zeros. This condition flags the TX Control unit to do one last shift, then deactivate SEND, and then set the interrupt flag TI. Both of these actions occur at S1P1.

Reception is initiated by the condition REN = 1 and RI = 0. At the end of the next MCU machine cycle, the RX Control unit writes the bits 11111110 to the receive shift register, and in the next clock phase activates RECEIVE. RECEIVE enables the SHIFT CLOCK signal to the alternate function on the port containing the pin, TxD. Each pulse of SHIFT CLOCK moves the contents of the receive shift register one position to the left while RECEIVE is active. The value that comes in from the right is the value that was sampled at the RxD pin. As data bits come in from the right, 1s shift out to the left. When the 0 that was initially loaded into the right-most position arrives at the left-most position in the shift register, it flags the RX Control unit to do one last shift, and then it loads SBUF. After this, RECEIVE is cleared, and the receive interrupt flag RI is set.

While transmitting, bytes are shifted out MSB first, and when receiving, bytes are shifted in MSB first, through the Acknowledge Bit register as shown in [Figure 42 on page 128](#).

23.10.1 Bus wait condition

After the SIOE finishes receiving a byte in Receive mode, or transmitting a byte in Transmit mode, the INTR flag (in S1STA) is set and automatically a wait condition is imposed on the I²C bus (SCL held low by SIOE). In Transmit mode, this wait condition is released as soon as the MCU writes any byte to S1DAT. In Receive mode, the wait condition is released as soon as the MCU reads the S1DAT register.

This method allows the user to handle transmit and receive operations within an interrupt service routine. The SIOE will automatically stall the I²C bus at the appropriate time, giving the MCU time to get the next byte ready to transmit or time to read the byte that was just received.

Table 80. S1DAT: I²C data shift register (SFR DEh, reset value 00h)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
S1DAT[7:0]							

Table 81. S1DAT register bit definition

Bit	Symbol	R/W	Function
7:0	S1DAT[7:0]	R/W	Holds the data byte to be transmitted in Transmit mode, or it holds the data byte received in Receiver mode.

23.11 I²C address register (S1ADR)

The S1ADR register ([Table 82](#)) holds the 7-bit device address used when the SIOE is operating as a Slave. When the SIOE receives an address from a Master, it will compare this address to the contents of S1ADR, as shown in [Figure 42 on page 128](#).

If the 7 bits match, the INTR Interrupt flag (in S1STA) is set, and the ADDR Bit (in S1CON) is set. The SIOE cannot modify the contents S1ADR, and S1ADR is not used during Master mode.

Table 82. S1ADR: I²C address register (SFR DFh, reset value 00h)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
SLA6	SLA5	SLA4	SLA3	SLA2	SLA1	SLA0	–

Table 83. S1ADR register bit definition

Bit	Symbol	R/W	Function
7:1	SLA[6:0]	R/W	Stores desired 7-bit device address, used when SIOE is in Slave mode.
0	–	–	Not used

Table 109. UIE2 register bit definition

Bit	Symbol	R/W	Definition
7	–	–	Reserved
6	–	–	Reserved
5	–	–	Reserved
4	OUT4IE	R/W	Enable Endpoint 4 OUT FIFO interrupt
3	OUT3IE	R/W	Enable Endpoint 3 OUT FIFO interrupt
2	OUT2IE	R/W	Enable Endpoint 2 OUT FIFO interrupt
1	OUT1IE	R/W	Enable Endpoint 1 OUT FIFO interrupt
0	OUT0IE	R/W	Enable Endpoint 0 OUT FIFO interrupt

- USB IN FIFO NAK interrupt enable register (UIE3)

When an endpoint's IN FIFO is empty and an IN transaction to that endpoint has been received, the SIE sends a NAK handshake token since there is no data ready for it to send.

The UIE3 register (see [Table 110](#)) is used to enable each endpoint's IN FIFO NAK Interrupt.

Table 110. USB IN FIFO NAK interrupt enable register (UIE3 0E7h, reset value 00h)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
–	–	–	NAK4IE	NAK3IE	NAK2IE	NAK1IE	NAK0IE

Table 111. UIE3 register bit definition

Bit	Symbol	R/W	Definition
7	–	–	Reserved
6	–	–	Reserved
5	–	–	Reserved
4	NAK4IE	R/W	Enable Endpoint 4 IN FIFO NAK interrupt
3	NAK3IE	R/W	Enable Endpoint 3 IN FIFO NAK interrupt
2	NAK2IE	R/W	Enable Endpoint 2 IN FIFO NAK interrupt
1	NAK1IE	R/W	Enable Endpoint 1 IN FIFO NAK interrupt
0	NAK0IE	R/W	Enable Endpoint 0 IN FIFO NAK interrupt

- USB FIFO base address high and low registers (UBASEH and UBASEL)
 All 10 Endpoint FIFOs share the same 64-byte address range. The 16-bit base address for the FIFOs is specified using the USB base address registers (see [Table 130](#) and [Table 132](#)). The USB endpoint select register (see [Table 124 on page 172](#)) selects the direction and the Endpoint for the FIFO that is accessed when addressing the 64-bytes of XDATA space starting with the base address specified in the base address registers. The base address is a 64-byte segment where the lower 6 bits of the base register are hardwired to '0.'

Important note: The USB FIFO base address must be set to an open 64-byte segment in the XDATA space. Care should be taken to ensure that there is no overlap of addresses between the USB FIFOs and the flash memory, SRAM, csiop registers, and anything else accessed in the XDATA space. While the logic in the PSD module handles overlap of flash memory, SRAM, and the csiop registers with a fixed priority (see [Section 28.1: PSD module functional description on page 192](#)), this is not the case with the USB FIFOs. Unpredictable results as well as potential damage to the device may occur if there is an overlap of addresses.

Table 130. USB FIFO base address high register (UBASEH 0F3h, reset value 00h)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
BASEADDR[15:8]							

Table 131. UBASEH register bit definition

Bit	Symbol	R/W	Definition
7:0	BASEADDR [15:8]	R/W	The upper 8 bits of the 16-bit base address for USB FIFOs to be mapped in XDATA space

Table 132. USB FIFO base address low register (UBASEL 0F4h, reset value 00h)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
BASEADDR[7:6]		0	0	0	0	0	0

Table 133. UBASEL register bit definition

Bit	Symbol	R/W	Definition
7:6	BASEADDR [7:6]	R/W	Bits 7 and 6 of the 16-bit base address for the USB FIFOs to be mapped in XDATA space
5:0	BASEADDR [5:0]	R	Hardwired '0'

Table 153. PCASTA register bit definition (continued)

Bit	Symbol	Function
5	INTF4	TCM4 Interrupt flag Set by hardware when a match or capture event occurs. Must be clear with software.
4	INTF3	TCM3 Interrupt flag Set by hardware when a match or capture event occurs. Must be clear with software.
3	OVF0	PCA0 Counter OverFlow flag Set by hardware when the counter rolls over. OVF0 flags an interrupt if Bit EOVI in PCAON0 is set. OVF1 may be set with either hardware or software but can only be cleared with software.
2	INTF2	TCM2 Interrupt flag Set by hardware when a match or capture event occurs. Must be clear with software.
1	INTF1	TCM1 Interrupt flag Set by hardware when a match or capture event occurs. Must be clear with software.
0	INTF0	TCM0 Interrupt flag Set by hardware when a match or capture event occurs. Must be clear with software.

27.13 TCM interrupts

There are 8 TCM interrupts: 6 match or capture interrupts and two counter overflow interrupts. The 8 interrupts are "ORed" as one PCA interrupt to the CPU.

By the nature of PCA application, it is unlikely that many of the interrupts occur simultaneously. If they do, the CPU has to read the interrupt flags and determine which one to serve. The software has to clear the interrupt flag in the status register after serving the interrupt.

Table 154. TCMMODE0 - TCMMODE5 (6 registers, reset value 00h)

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
EINTF	E_COMP	CAP_PE	CAP_NE	MATCH	TOGGLE	PWM[1:0]	

Table 155. TCMMODE0 - TCMMODE5 register bit definition

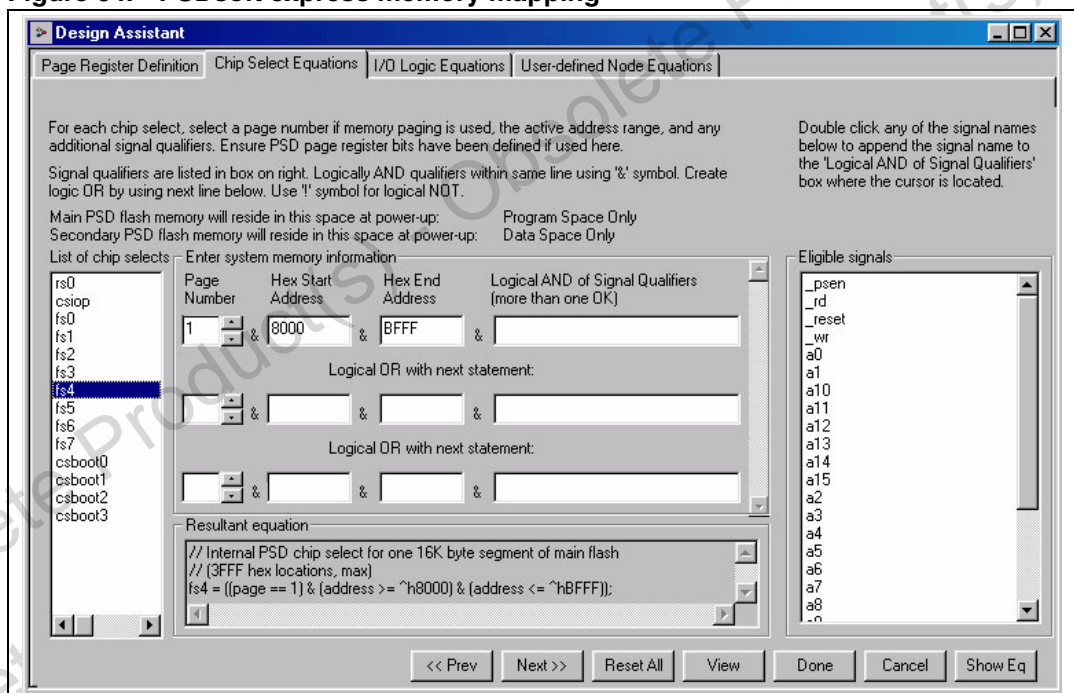
Bit	Symbol	Function
7	EINTF	1 - Enable the interrupt flags (INTF) in the status register to generate an interrupt.
6	E_COMP	1 - Enable the comparator when set
5	CAP_PE	1 - Enable Capture Mode, a positive edge on the CEXn pin.
4	CAP_NE	1 - Enable Capture Mode, a negative edge on the CEXn pin.
3	MATCH	1 - A match from the comparator sets the INTF bits in the status register.

Table 159. HDL statement example generated from PSDsoft express for memory map

```

rs0      = ((address ≥ ^h0000) & (address ≤ ^h1FFF));
csiop    = ((address ≥ ^h2000) & (address ≤ ^h20FF));
fs0      = ((address ≥ ^h0000) & (address ≤ ^h3FFF));
fs1      = ((address ≥ ^h4000) & (address ≤ ^h7FFF));
fs2      = ((page == 0)          & (address ≥ ^h8000) & (address ≤ ^hBFFF));
fs3      = ((page == 0)          & (address ≥ ^hC000) & (address ≤ ^hFFFF));
fs4      = ((page == 1)          & (address ≥ ^h8000) & (address ≤ ^hBFFF));
fs5      = ((page == 1)          & (address ≥ ^hC000) & (address ≤ ^hFFFF));
fs6      = ((page == 2)          & (address ≥ ^h8000) & (address ≤ ^hBFFF));
fs7      = ((page == 2)          & (address ≥ ^hC000) & (address ≤ ^hFFFF));
csboot0  = ((address ≥ ^h8000) & (address ≤ ^h9FFF));
csboot1  = ((address ≥ ^hA000) & (address ≤ ^hBFFF));
csboot2  = ((address ≥ ^hC000) & (address ≤ ^hDFFF));
csboot3  = ((address ≥ ^hE000) & (address ≤ ^hFFFF));
    
```

Figure 64. PSDsoft express memory mapping



28.2.4 EEPROM emulation

EEPROM emulation is needed if it is desired to repeatedly change only a small number of bytes of data in Flash memory. In this case EEPROM emulation is needed because although Flash memory can be written byte-by-byte, it must be erased sector-by-sector, it is not erasable byte-by-byte (unlike EEPROM which is written AND erased byte-by-byte). So changing one or two bytes in Flash memory typically requires erasing an entire sector each time only one byte is changed within that sector.

However, two of the 8 Kbyte sectors of Secondary Flash memory may be used to emulate EEPROM by using a linked-list software technique to create a small data set that is

This unlocking sequence is typical for many Flash memories to prevent accidental WRITES by errant code. However, it is possible to bypass this unlocking sequence to save time while intentionally programming Flash memory.

Important note: The 8032 may not read and execute code from the same Flash memory array for which it is directing an instruction sequence. Or more simply stated, the 8032 may not read code from the same Flash array that is writing or erasing. Instead, the 8032 must execute code from an alternate memory (like SRAM or a different Flash array) while sending instruction sequences to a given Flash array. Since the two Flash memory arrays inside the PSD module device are completely independent, the 8032 may read code from one array while sending instructions to the other. It is possible, however, to suspend a sector erase operation in one particular Flash array in order to access a different sector within that same Flash array, then resume the erase later.

After a Flash memory array is programmed or erased it will go to "Read Array" mode, then the 8032 can read from Flash memory just as it would read from any ROM or SRAM device.

28.5.2 Flash memory instruction sequences

An instruction sequence consists of a sequence of specific byte WRITE and byte READ operations. Each byte written to either Flash memory array on the PSD module is received by a state machine inside the Flash array and sequentially decoded to execute an embedded algorithm. The algorithm is executed when the correct number of bytes are properly received and the time between two consecutive bytes is shorter than the time-out period of 80µs. Some instruction sequences are structured to include READ operations after the initial WRITE operations.

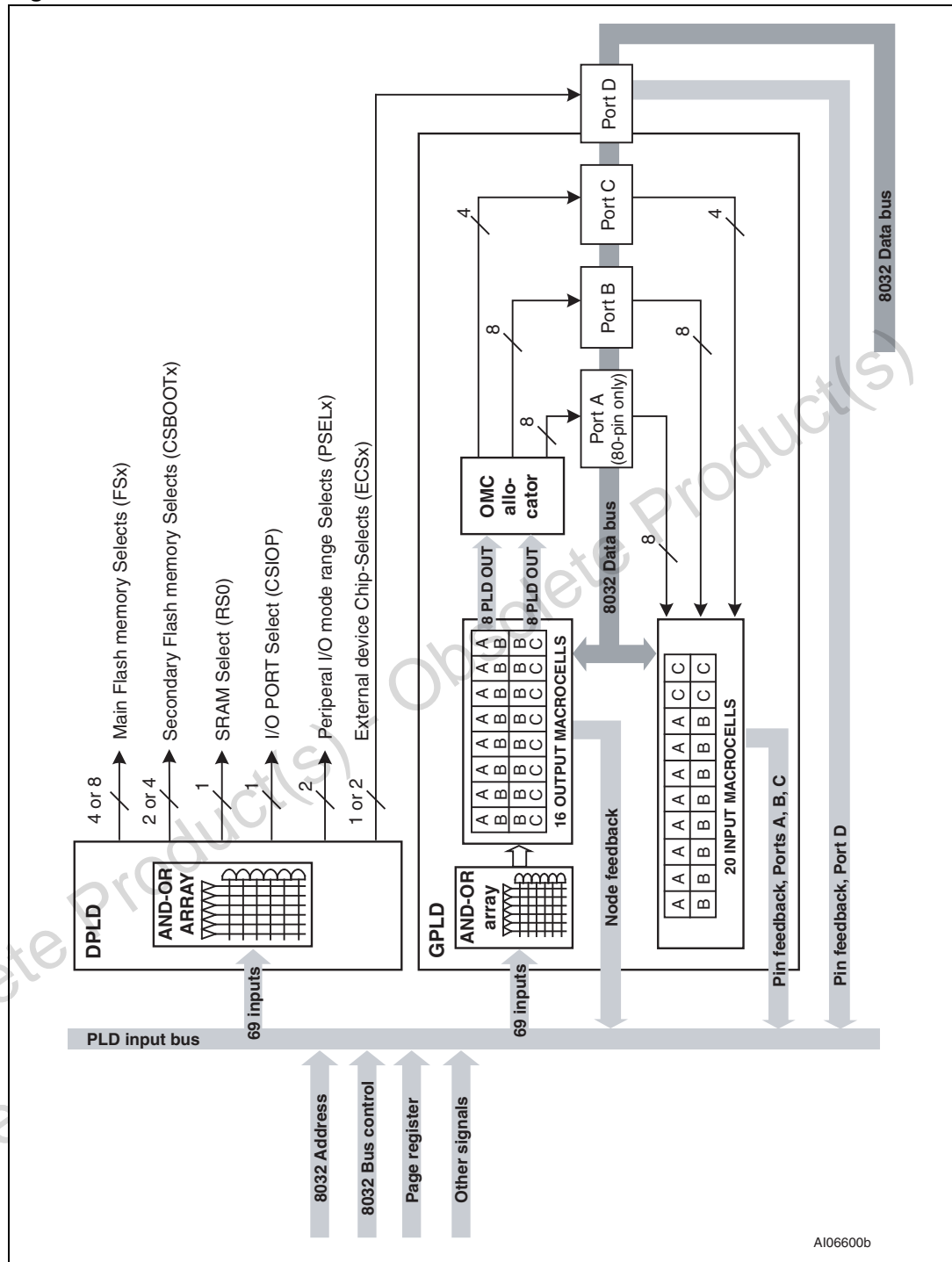
An instruction sequence must be followed exactly. Any invalid combination of instruction bytes or time-out between two consecutive bytes while addressing Flash memory resets the PSD module Flash logic into Read Array mode (where Flash memory is read like a ROM device). The Flash memories support instruction sequences summarized in [Table 163 on page 209](#).

- Program a byte
- Unlock Sequence Bypass
- Erase memory by array or by sector
- Suspend or resume a sector erase
- Reset to Read Array mode

The first two bytes of an instruction sequence are 8032 bus WRITE operations to "unlock" the Flash array, followed by writing a command byte. The bus operations consist of writing the data AAh to address X555h during the first bus cycle and data 55h to address XAAAh during the second bus cycle. 8032 address signals A12-A15 are "Don't care" during the instruction sequence during WRITE cycles. However, the appropriate sector select signal (*FSx* or *CSBOOTx*) from the DPLD must be active during the entire instruction sequence to complete the entire 8032 address (this includes the page number when memory paging is used). Ignoring A12-A15 means the user has more flexibility in memory mapping. For example, in many traditional Flash memories, instruction sequences must be written to addresses AAAAh and 5555h, not XAAAh and X555h like supported on the PSD module. When the user has to write to AAAAh and 5555h, the memory mapping options are limited.

The Main Flash and Secondary Flash memories each have the same instruction set shown in [Table 163 on page 209](#), but the sector select signals determine which memory array will receive and execute the instructions.

Figure 73. DPLD and GPLD



28.5.27 Decode PLD (DPLD)

The DPLD ([Figure 74 on page 223](#)) generates the following memory decode signals:

- Eight Main Flash memory sector select signals (FS0-FS7) with three product terms each
- Four Secondary Flash memory sector select signals (CSBOOT0-CSBOOT3) with three product terms each
- One SRAM select signal (RS0) with two product terms
- One select signal for the base address of 256 PSD module device control and status registers (csiop) with one product term
- Two external chip-select output signals for Port D pins, each with one product term (52-pin devices only have one pin on Port D)
- Two chip-select signals (PSEL0, PSEL1) used to enable the 8032 data bus repeater function (Peripheral I/O mode) for Port A on 80-pin devices. Each has one product term.

A product term indicates the logical OR of two or more inputs. For example, three product terms in a DPLD output means the final output signal is capable of representing the logical OR of three different input signals, each input signal representing the logical AND of a combination of the 69 PLD inputs.

Using the signal FS0 for example, the user may create a 3-product term chip select signal that is logic true when any one of three different address ranges are true... FS0 = address range 1 OR address range 2 OR address range 3.

The phrase “one product term” is a bit misleading, but commonly used in this context. One product term is the logical AND of two or more inputs, with no OR logic involved at all, such as the CSIOP signal in [Figure 74 on page 223](#).

28.5.50 Port C structure

Port C supports the following operating modes on pins PC2, PC3, PC4, PC7:

- MCU I/O Mode
- GPLD Output Mode from Output Macrocells MCELLBC2, MCELLBC3, MCELLBC4, MCELLBC7
- GPLD Input Mode to Input Macrocells IMCC2, IMCC3, IMCC4, IMCC7

See [Figure 86 on page 246](#) for detail.

Port C pins can also be configured in PSDsoft for other dedicated functions:

- Pins PC3 and PC4 support TSTAT and \overline{TERR} status indicators, to reduce the amount of time required for JTAG ISP programming. These two pins must be used together for this function, adding to the four standard JTAG signals. When TSTAT and \overline{TERR} are used, it is referred to as “6-pin JTAG”. PC3 and PC4 cannot be used for other functions if they are used for 6-pin JTAG. See [Section 28.6.1: JTAG ISP and JTAG debug on page 257](#) for details.
- PC3 can be used as an output to indicate when a Flash memory program or erase operation has completed. This is specified in PSDsoft Express as [Section 28.5.13: Ready/Busy \(PC3\) on page 215](#).

The remaining four pins (TDI, TDO, TCK, TMS) on Port C are dedicated to the JTAG function and cannot be used for any other function. See [Section 28.6.1: JTAG ISP and JTAG debug on page 257](#).

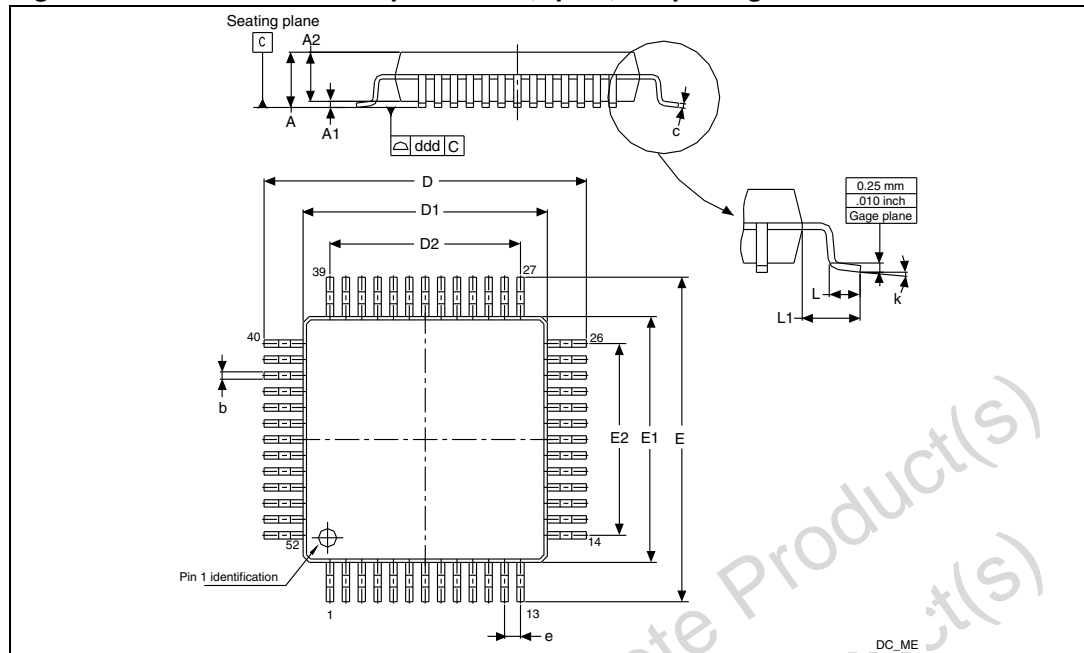
Port C also supports the Open Drain output drive type options on pins PC2, PC3, PC4, and PC7 using the csiop Drive Select registers.

Table 212. PSD module DC characteristics (with 5 V V_{DD})

Symbol	Parameter		Test condition (in addition to those in Table 211 on page 271)	Min.	Typ.	Max.	Unit
V _{IH}	Input high voltage		4.5 V < V _{DD} < 5.5 V	2		V _{DD} +0.5	V
V _{IL}	Input low voltage		4.5 V < V _{DD} < 5.5 V	-0.5		0.8	V
V _{LKO}	V _{DD} (min) for Flash erase and program			2.5		4.2	V
V _{OL}	Output low voltage		I _{OL} = 20 μA, V _{DD} = 4.5 V		0.01	0.1	V
			I _{OL} = 8 mA, V _{DD} = 4.5 V		0.25	0.45	V
V _{OH}	Output high voltage		I _{OH} = -20 μA, V _{DD} = 4.5 V	4.4	4.49		V
			I _{OH} = -2 mA, V _{DD} = 4.5 V	2.4	3.9		V
I _{SB}	Standby supply current for power-down mode		$\overline{CS1} > V_{DD} - 0.3 V^{(1)(2)}$		120	250	μA
I _{LI}	Input leakage current		V _{SS} < V _{IN} < V _{DD}	-1	±0.1	1	μA
I _{LO}	Output leakage current		0.45 < V _{OUT} < V _{DD}	-10	±5	10	μA
I _{CC} (DC) ⁽³⁾	Operating supply current	PLD only	PLD_TURBO = Off, f = 0 MHz ⁽³⁾		0		μA/PT
			PLD_TURBO = On, f = 0 MHz		400	700	μA/PT
		Flash memory	During Flash memory WRITE/Erase Only		15	30	mA
			Read only, f = 0 MHz		0	0	mA
		SRAM	f = 0 MHz		0	0	mA
I _{CC} (AC) ⁽³⁾	PLD AC adder					(4)	
	Flash memory AC adder				1.5	2.5	mA/MHz
	SRAM AC adder				1.5	3.0	mA/MHz

1. Internal Power-down mode is active.
2. PLD is in non-Turbo mode, and none of the inputs are switching.
3. I_{OUT} = 0 mA.
4. Please see [Figure 95 on page 265](#) for the PLD current calculation.

Figure 113. LQFP52 – 52-lead plastic thin, quad, flat package outline



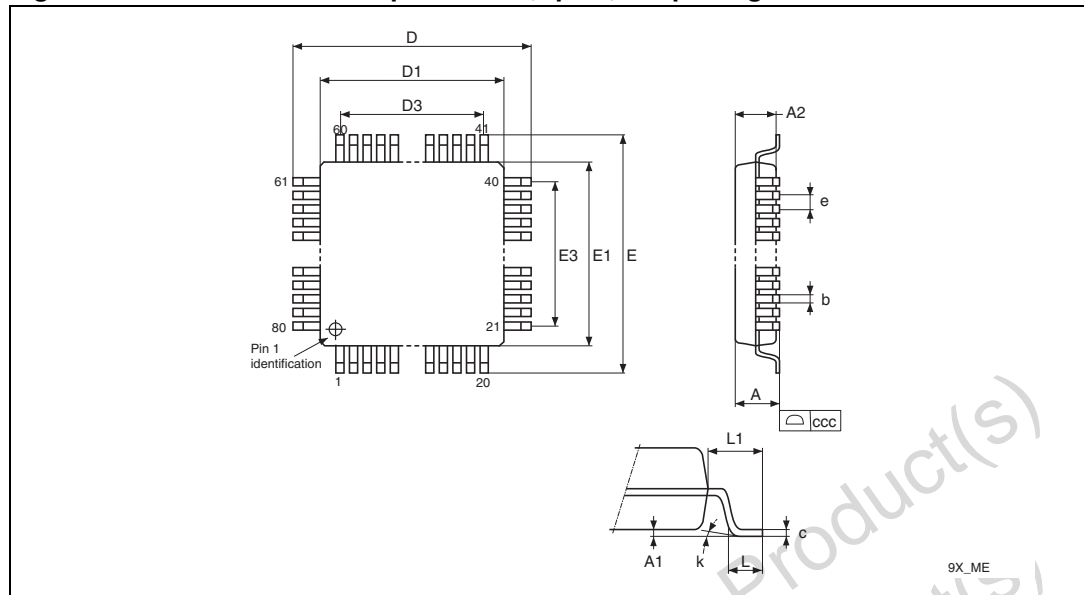
1. Drawing is not to scale.

Table 237. LQFP52 – 52-lead plastic thin, quad, flat package mechanical data

Symbol	millimeters			inches ⁽¹⁾		
	Typ	Min	Max	Typ	Min	Max
A			1.60			0.063
A1		0.05	0.15		0.002	0.0059
A2		1.35	1.45		0.0531	0.0571
b		0.22	0.38		0.0087	0.015
C		0.09	0.2		0.0035	0.0079
D	12			0.4724		
D1	10			0.3937		
D2	7.8			0.3071		
E	12			0.4724		
E1	10			0.3937		
E2	7.8			0.3071		
e	0.65			0.0256		
L		0.45	0.75		0.0177	0.0295
L1	1			0.0394		
k		0°	7°		0°	7°
ddd		0.100			0.0039	

1. Values in inches are converted from mm and rounded to 4 decimal digits.

Figure 114. LQFP80 – 80-lead plastic thin, quad, flat package outline



1. Drawing is not to scale.

Table 238. LQFP80 – 80-lead plastic thin, quad, flat package mechanical data

Symbol	millimeters			inches ⁽¹⁾		
	Typ	Min	Max	Typ	Min	Max
A			1.600			0.0630
A1		0.050	0.150		0.0020	0.0059
A2	1.400	1.350	1.450	0.0551	0.0531	0.0571
b	0.220	0.170	0.270	0.0087	0.0067	0.0106
C		0.090	0.200		0.0035	0.0079
D	14.000			0.5512		
D1	12.000			0.4724		
D3	9.500			0.3740		
E	14.000			0.5512		
E1	12.000			0.4724		
E3	9.500			0.3740		
e	0.500			0.0197		
L	0.600	0.450	0.750	0.0236	0.0177	0.0295
L1	1.000			0.0394		
k		0°	7°		0°	7°
ccc		0.080			0.0031	

1. Values in inches are converted from mm and rounded to 4 decimal digits.

Workaround

Revision A and B - When a USB reset is detected, the USB SIE's registers must be initialized appropriately by the firmware. The 3400 USB firmware examples clear USB SIE's registers if USB reset is detected.

34.4 Data toggle**Description**

The data toggle bit is read only.

Impact on application

The IN FIFO data toggle bit is controlled exclusively by the USB SIE; therefore, it is not possible to change the state of the data toggle bit by firmware.

Workaround

Revision A - For cases where the data toggle bit must be reset, such as after a Clear Feature/Stall request, sending the subsequent data on that endpoint twice results in getting the data toggle bit back to the state that it should be.

Revision B - A change in silicon was made so that the data toggle bit is reset by disabling and then enabling the respective endpoint's FIFO.

34.5 USB FIFO accessibility**Description**

The USB FIFO is only accessible by firmware and not by a JTAG debugger.

Impact on application

Using a JTAG debugger, it is not possible to view the USB FIFO's contents in a memory dump window.

Workaround

Revision A and B - None identified at this time.

34.6 Erroneous resend of data packet**Description**

When a data packet is sent the respective IN FIFO busy bit is not automatically cleared by the USB SIE. This can cause a data packet to be erroneously resent to the host in response to an IN PID immediately after the first correct transmission of this data packet.

Impact on application

Since the Data Toggle in the retransmitted data packet is toggled from when the data was first sent, the host will treat this packet as valid. If the identified workaround is not